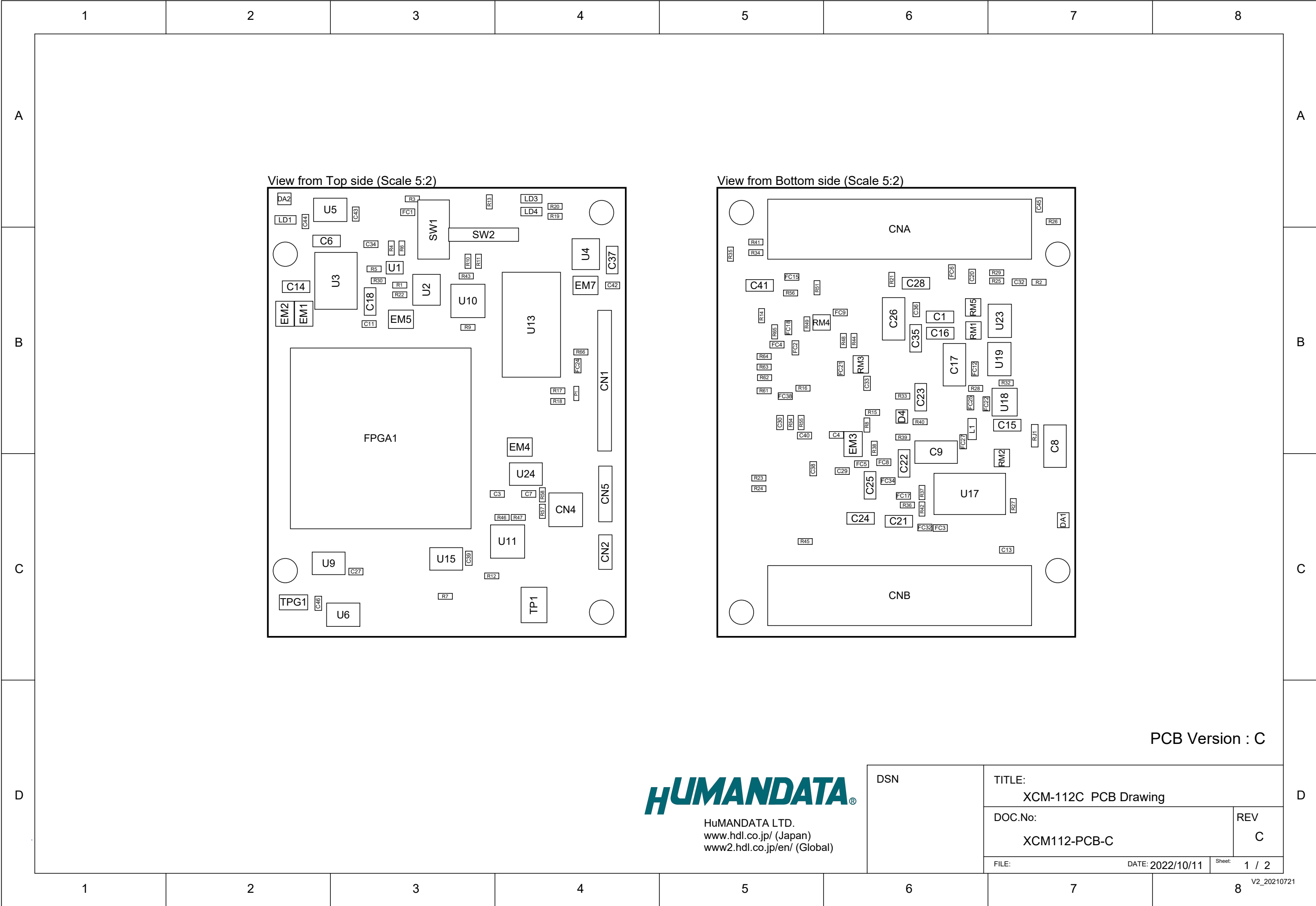
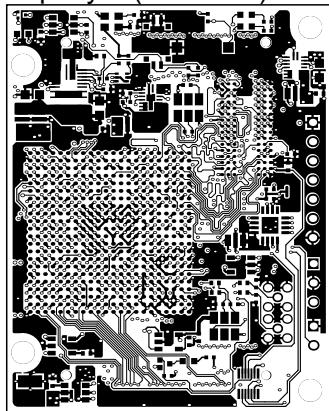
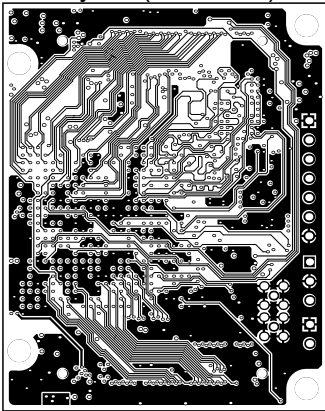
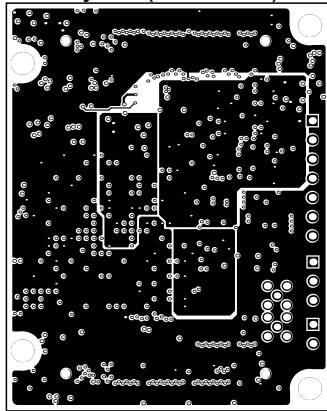
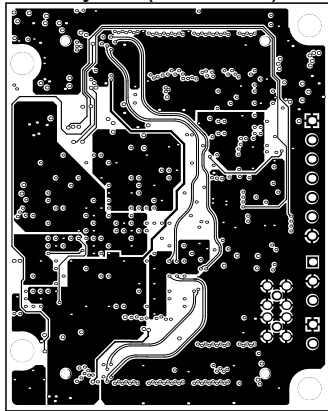
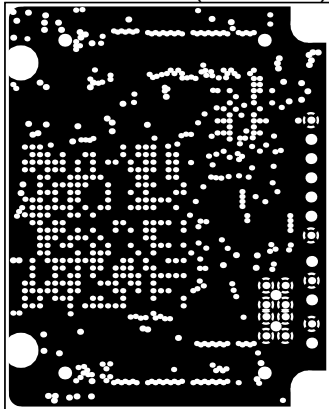
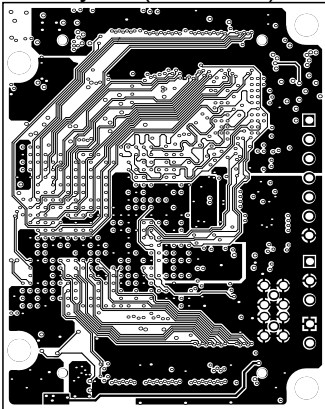
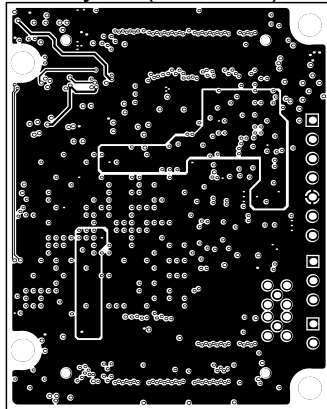
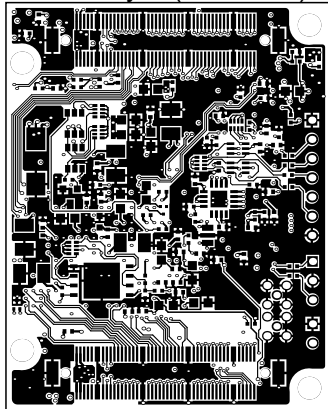




	1	2	3	4	5	6	7	8											
A									A										
B	TopLayer (Scale 1:1)  MidLayer2 (Scale 1:1)  MidLayer4 (Scale 1:1)  MidLayer6 (Scale 1:1) 								B										
C	InternalPlane1 (Scale 1:1)  MidLayer3 (Scale 1:1)  MidLayer5 (Scale 1:1)  BottomLayer (Scale 1:1) 								C										
D	PCB Version : C  HuMANDATA LTD. www.hdl.co.jp/ (Japan) www2.hdl.co.jp/en/ (Global) <table><tr><td rowspan="3">DSN</td><td colspan="2">TITLE: XCM-112C PCB Drawing</td><td>REV C</td></tr><tr><td colspan="2">DOC.No: XCM112-PCB-C</td><td></td></tr><tr><td>FILE:</td><td>DATE: 2022/10/11</td><td>Sheet: 2 / 2</td></tr></table>								DSN	TITLE: XCM-112C PCB Drawing		REV C	DOC.No: XCM112-PCB-C			FILE:	DATE: 2022/10/11	Sheet: 2 / 2	D
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